

Technical Data Sheet

1.9mm Round Subminiature Lead LEDs

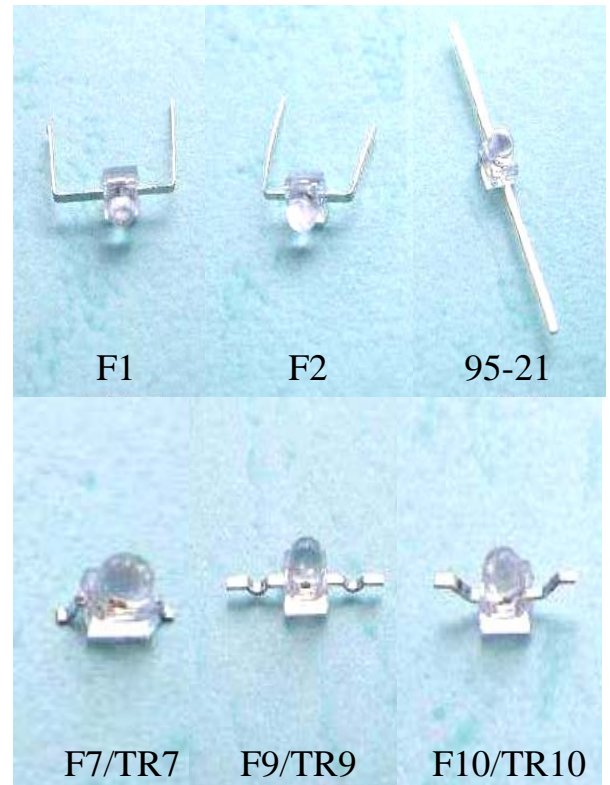
95-21SUBC/S400-XX/XXX

Features

- Package in 12mm tape on 7" diameter reels.
- Compatible with automatic placement equipment.
- EIA Std. package.
- Mono-color type.
- Pb-free

Descriptions

- The 95-21 SMD taping is much smaller than leaded components . Thus enable smaller board size. Higher packing density. Reduced storage space and finally smaller equipment to be obtained.
- Besides, light weight makes them ideal for miniature applications.
- Furthermore by automation assembly machines the accuracy is anticipated.



Applications

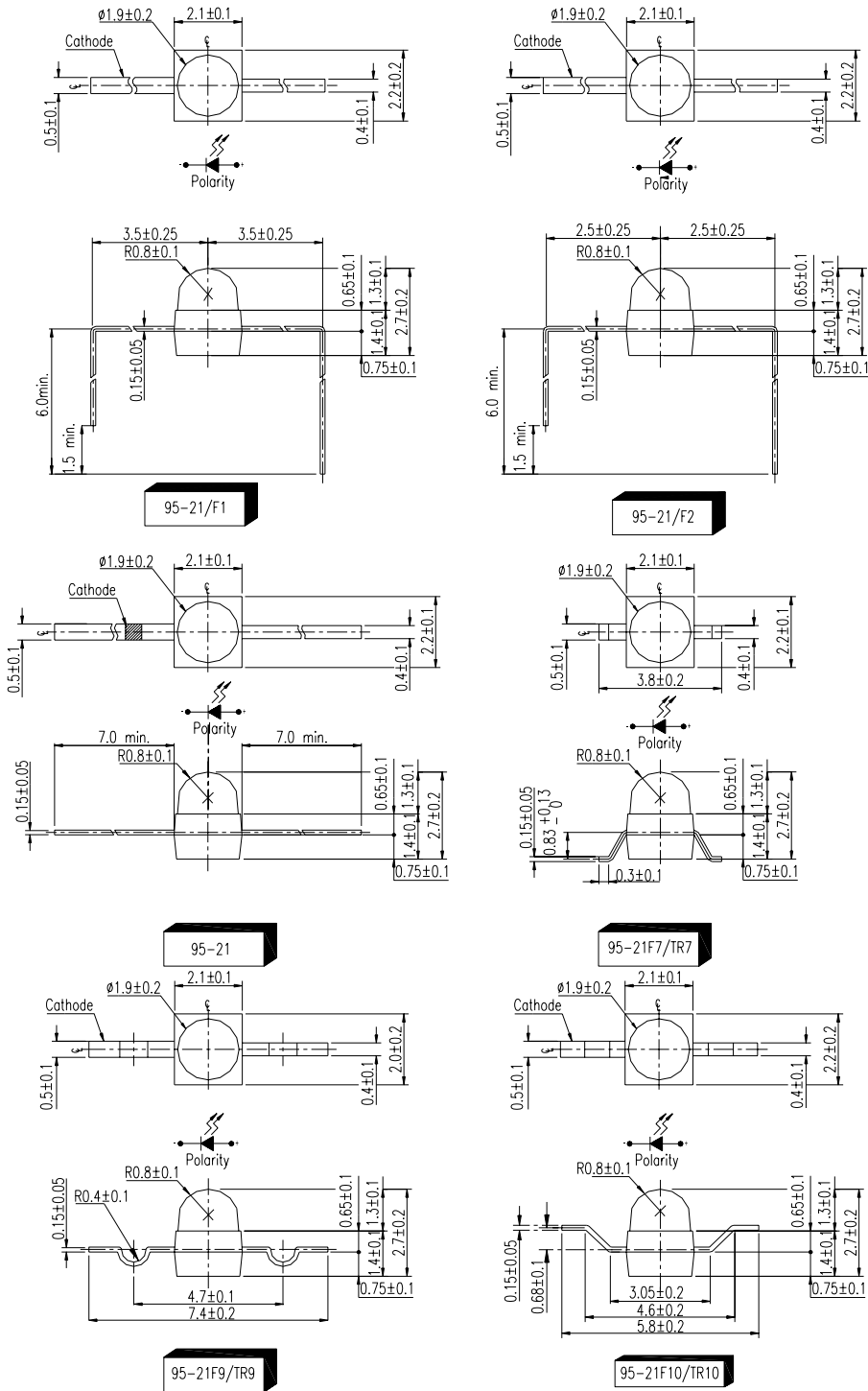
- Small indicator for indoor applications.
- Flat backlight for LCD, switches and symbols.
- Indicator and backlight in office equipment.
- Indicator and backlight for battery driven equipment.
- Indicator and backlight for audio and video equipment.
- Automotive : backlighting in dashboards and switches.
- Telecommunication : indicator and backlighting in telephone and fax.

Device Selection Guide

PART NO.	Chip		Lens Color
	Material	Emitted Color	
95-21SUBC/S400-XX/XXX	InGaN	Super Blue	Water Clear

95-21SUBC/S400-XX/XXX

Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Electrostatic Discharge	ESD	150	V
Power Dissipation	P _d	110	mW
Peak Forward Current (Duty 1/10 @ 1KHz)	I _{FP}	100	mA
Soldering Temperature	T _{sol}	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Chip Rank	MIN.	TYP.	MAX.	Unit	Condition
Luminous Intensity	I _v	A3	----	24	----	mcd	I _F =2mA
			320	500	----		I _F =20mA
		A4	----	30	----		I _F =2mA
			400	630	----		I _F =20mA
		A5	----	38	----		I _F =2mA
			500	800	----		I _F =20mA
Viewing Angle	2θ 1/2	----	----	25	----	deg	I _F =20mA
Peak Wavelength	λ _p	----	----	468	----	nm	
Dominant Wavelength	λ _d	----	----	470	----	nm	
Spectrum Radiation Bandwidth	Δλ	----	----	35	----	nm	
Forward Voltage	V _F	----	----	3.5	4.3	V	
Reverse Current	I _R	----	----	----	50	μA	V _R =5V

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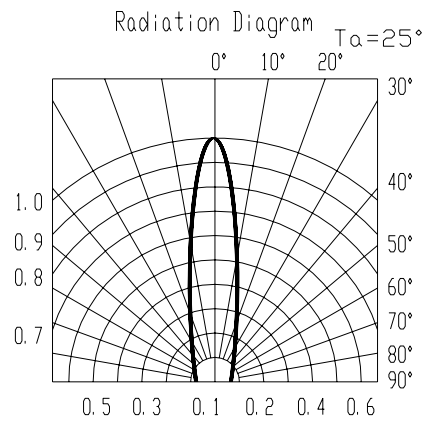
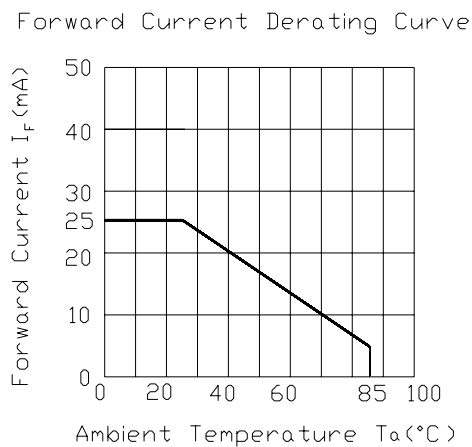
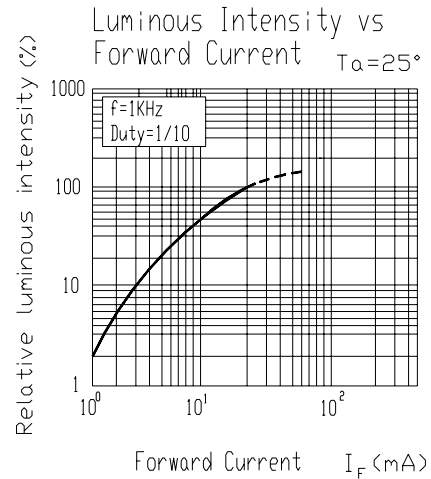
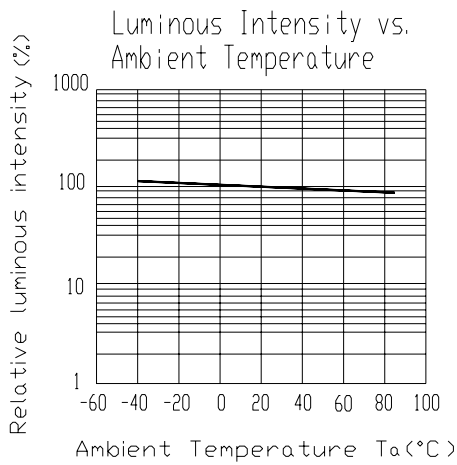
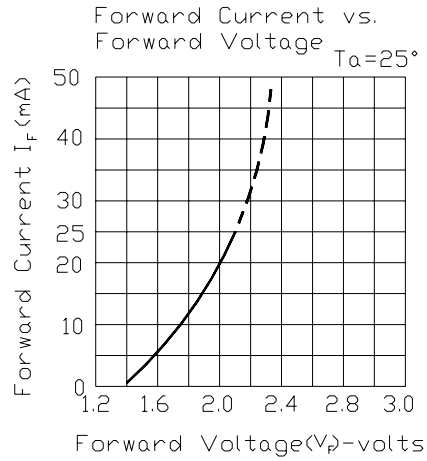
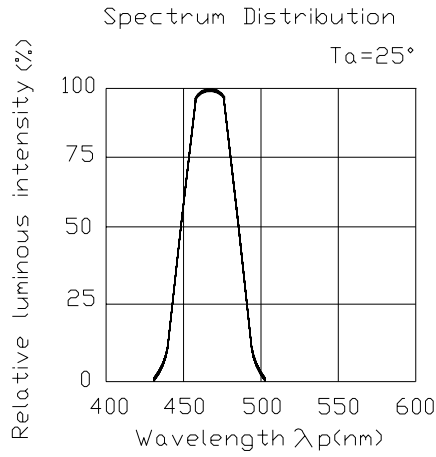
1:Chip Rank

2:Packing Method:

(1) None,F1,F2, F7,F9,F10 : Bulk

(2) TR7,TR9,TR10 : Taping

Typical Electro-Optical Characteristics Curves



Label explanation

CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

EVERLIGHT

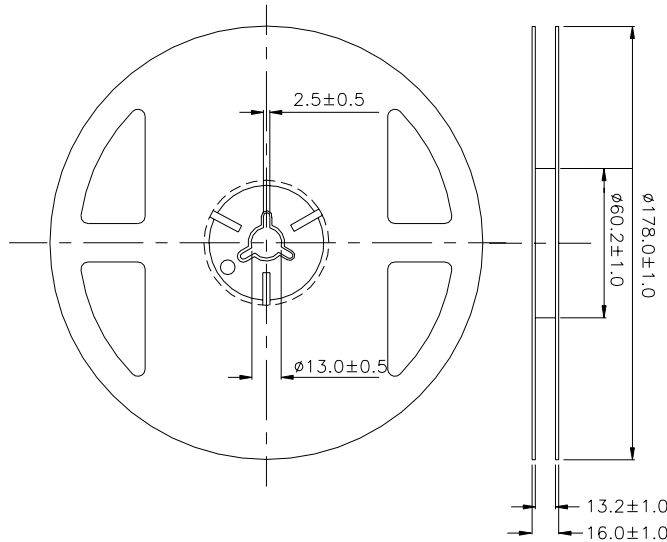
CPN :
 P/N: XXXXXXXXXXXX

 XX-XXXXXXXX CAT: Bin Iv
 QTY: XXXX HUE: Bin λd
 REF: Bin VF
 LOT NO: XXXXXXXXXXX


MADE IN TAIWAN

Reel & Carrier Tape Dimensions

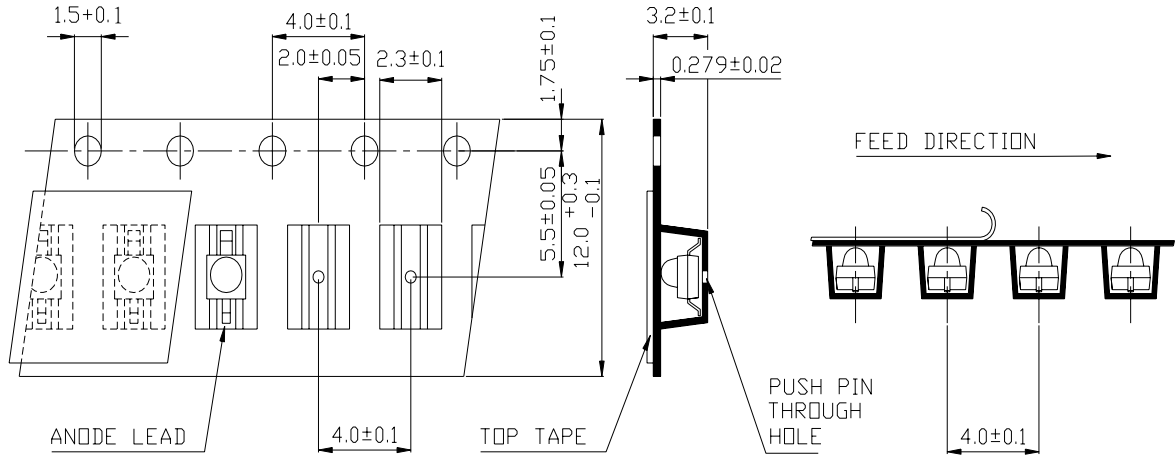
7-12mm-real



Note: The tolerances unless mentioned are ± 0.1 , unit=mm.

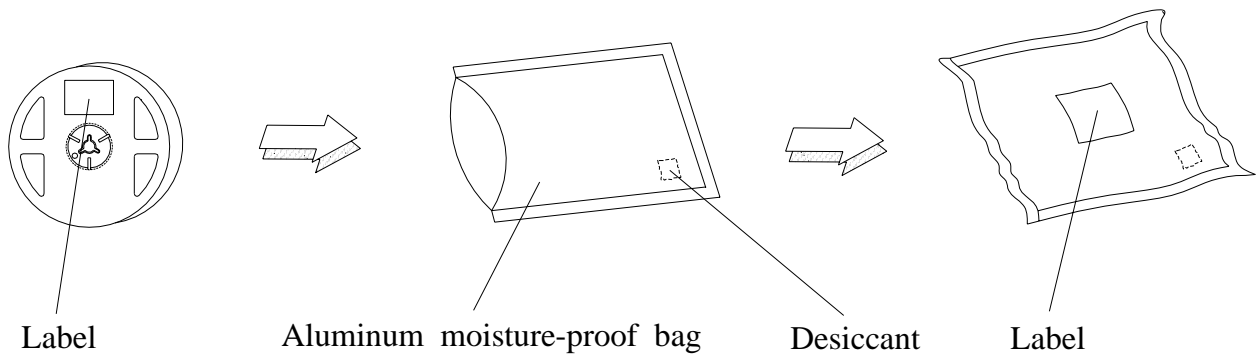
95-21SUBC/S400-XX/XXX

Loaded quantity 1000 PCS per reel



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$,Unit = mm

Moisture Resistant Packaging



95-21SUBC/S400-XX/XXX
Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90 %

LTPD : 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C ±5°C Min. 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	H : +100°C 15 min. § 5 min. L : -40°C 15 min.	300 Cycles	22 Pcs.	0/1
3	Thermal Shock	H : +100°C 5 min. § 10 sec. L : -10°C 5 min.	300 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C / 85% RH	1000 Hrs.	22 Pcs.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

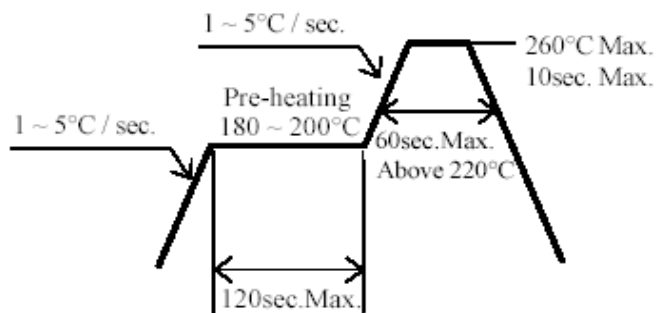
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

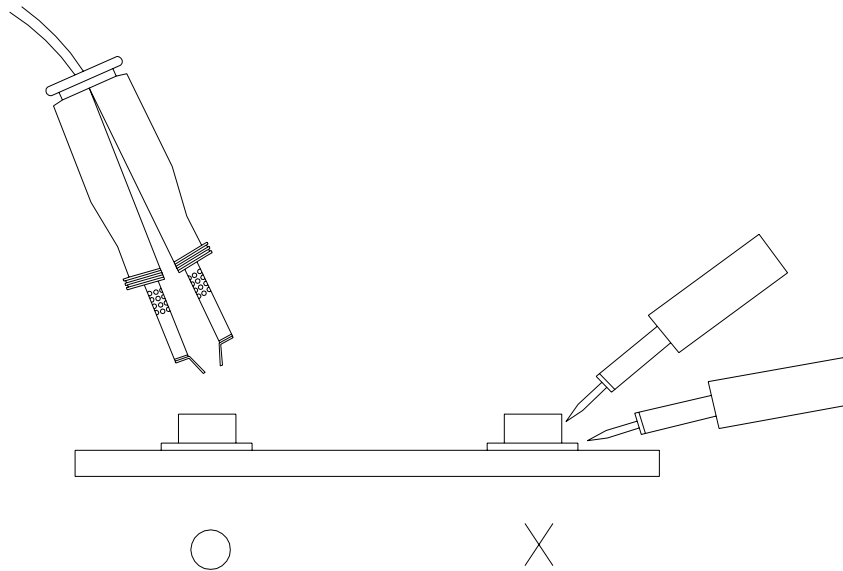
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.
Office: No 25, Lane 76, Sec 3, Chung Yang Rd,
Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936
Fax: 886-2267-6244, 2267-6189, 2267-6306
<http://www.everlight.com>